# 2SB1154

### Silicon PNP epitaxial planar type

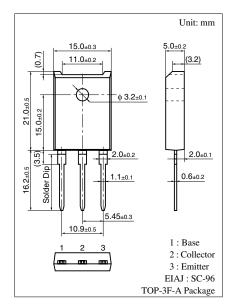
For power switching Complementary to 2SD1705

#### Features

- $\bullet$  Low collector to emitter saturation voltage  $V_{CE(sat)}$
- $\bullet$  Satisfactory linearity of forward current transfer ratio  $h_{\text{FE}}$
- $\bullet$  Large collector current  $I_{C}$
- Full-pack package which can be installed to the heat sink with one screw

ADSolute Maximum Hatings $T_{\rm C} = 25$ C							
Parameter		Symbol	Rating	Unit			
Collector to base voltage		V <sub>CBO</sub>	-130	V			
Collector to emitter voltage		V <sub>CEO</sub>	-80	V			
Emitter to base voltage		V <sub>EBO</sub>	-7	V			
Peak collector current		I <sub>CP</sub>	-20	А			
Collector current		I <sub>C</sub>	-10	А			
Collector power	$T_C = 25^{\circ}C$	P <sub>C</sub>	70	W			
dissipation	$T_a = 25^{\circ}C$		3				
Junction temperature		Tj	150	°C			
Storage temperature		T <sub>stg</sub>	-55 to +150	°C			

#### Absolute Maximum Ratings $T_C = 25^{\circ}C$



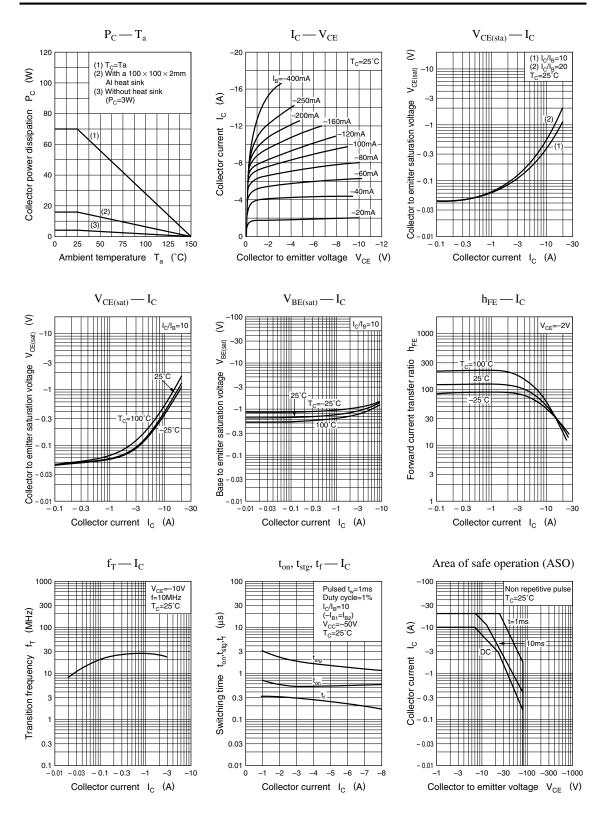
#### **Electrical Characteristics** $T_C = 25^{\circ}C$

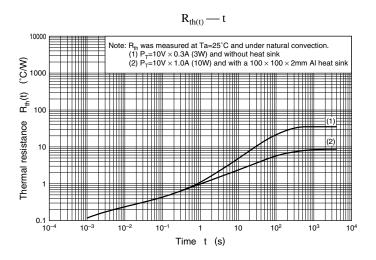
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = -100 \text{ V}, I_E = 0$			-10	μΑ
Emitter cutoff current	I <sub>EBO</sub>	$V_{EB} = -5 V, I_C = 0$			-50	μΑ
Collector to emitter voltage	V <sub>CEO</sub>	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = 0$	-80			V
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = -2 V, I_C = -0.1 A$	45			
	h <sub>FE2</sub> *	$V_{CE} = -2 V, I_C = -3 A$	90		260	
	h <sub>FE3</sub>	$V_{CE} = -2 V, I_C = -6 A$	30			
Collector to emitter saturation voltage	V <sub>CE(sat)1</sub>	$I_{\rm C} = -6$ A, $I_{\rm B} = -0.3$ A			- 0.5	V
	V <sub>CE(sat)2</sub>	$I_{\rm C} = -10 \text{ A}, I_{\rm B} = -1 \text{ A}$			-1.5	V
Base to emitter saturation voltage	V <sub>BE(sat)1</sub>	$I_{\rm C} = -6$ A, $I_{\rm B} = -0.3$ A			-1.5	V
	V <sub>BE(sat)2</sub>	$I_{\rm C} = -10 \text{ A}, I_{\rm B} = -1 \text{ A}$			-2.5	V
Transition frequency	$f_T$	$V_{CE} = -10 \text{ V}, I_C = -0.5 \text{ A}, f = 10 \text{ MHz}$		30		MHz
Turn-on time	t <sub>on</sub>	$I_{C} = -6 \text{ A}, I_{B1} = -0.6 \text{ A}, I_{B2} = 0.6 \text{ A},$		0.5		μs
Storage time	t <sub>stg</sub>	$V_{\rm CC} = -50 \text{ V}$		1.0		μs
Fall time	t <sub>f</sub>			0.2		μs

Note) \*: Rank classification

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Rank	Q	Р		
$h_{\text{FE2}}$	90 to 180	130 to 260		





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